



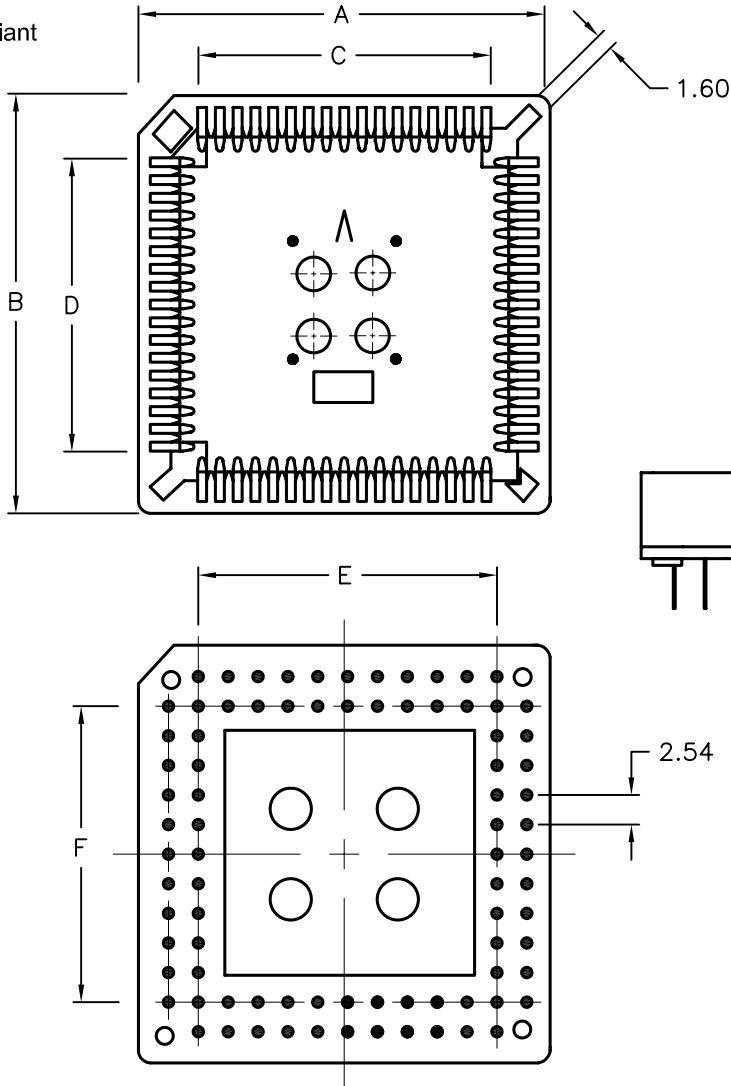
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SPC-F005.DWG

REVISIONS

DOC. NO. SPC-F005 * Effective: 7/8/02 * DCP No: 1398

DCP #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE
1878	A	RELEASED	EO	6/5/06	YA	6/19/06	HO	6/19/06



SPECIFICATION:

MATERIAL

Insulator: PBT, Rated UL94V-0

Contacts: Brass

CONTACT PLATING:

Underplate: 50m" Nickel

Solder Tails Area: 80m" ~ 120m" Tin/Lead Free(Matte Tin)

ELECTRICAL

Operation Voltage: 250 VAC Max.

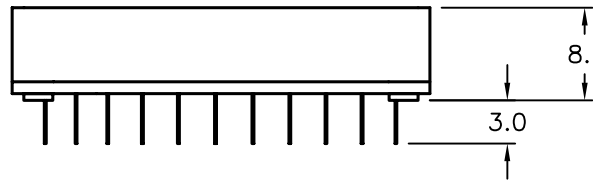
Current Rating: 3 Amps Max.

Contact Resistance: 30 miliohms Max.

Insulation Resistance: 1000 Megohms Min

Dielectric Withstanding Voltage: 500 VAC / Minute

Operating Temperature: -40°C to +105°C



SPC Type No.	Number of pins	Dimensions					
		A	B	C	D	E	F
SPC15567	28	18.3	18.3	7.62	7.62	7.62	7.62
SPC15568	32	18.0	20.8	7.62	10.16	7.62	5.08
SPC15569	44	23.5	23.5	12.70	12.70	12.70	12.70
SPC15570	68	31.56	31.56	20.32	20.32	20.32	20.32
SPC15571	84	36.66	36.66	25.40	25.40	25.40	25.40

DISCLAIMER: ALL STATEMENTS AND TECHNICAL INFORMATION CONTAINED HEREIN ARE BASED UPON INFORMATION AND/OR TESTS WE BELIEVE TO BE ACCURATE AND RELIABLE. SINCE CONDITIONS OF USE ARE BEYOND OUR CONTROL, THE USER SHALL DETERMINE THE SUITABILITY OF THE PRODUCT FOR THE INTENDED USE AND ASSUME ALL RISK AND LIABILITY WHATSOEVER IN CONNECTION THEREWITH.

TOLERANCES:

UNLESS OTHERWISE SPECIFIED
 ANG. ±5°
 X. ±0.5
 .X ±0.3
 .XX ±0.2

DRAWN BY:	DATE:
EKLAS ODISH	6/5/06
CHECKED BY:	DATE:
YILMAZ AKYONDEM	6/19/06
APPROVED BY:	DATE:
HISHAM ODISH	6/19/06

DRAWING TITLE: Thru Hole Chip Carrier, Plastic Leaded			
SIZE	DWG. NO.	ELECTRONIC FILE	REV
A	TA-774	TA-774.DWG	A
SCALE: NTS		U.O.M.: millimeters	SHEET: 1 OF 1